

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 7,014,552 B1  
APPLICATION NO. : 09/899871  
DATED : March 21, 2006  
INVENTOR(S) : Collier et al.

Page 1 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In the Claims:

Column 14, line 63,

Please add the following claims which were allowed during prosecution of the patent application, but were mistakenly omitted from the printed patent:

Claim 19. (original claim 10) The system of claim 1, wherein the spray element is adapted to be removed from the system.

Claim 20. (previously presented claim 23) A method for polishing multiple semiconductor topographies, comprising:

moving a polishing pad with respect to a semiconductor topography and a spray element;

polishing the semiconductor topography by positioning it against the moving polishing pad;

measuring an amount of matter adhered to the polishing pad subsequent to said polishing;

spraying a pressurized fluid from the spray element upon the polishing pad while moving the polishing pad, wherein said spraying is conducted based upon the amount of matter measured; and

removing matter adhered to the polishing pad.

Claim 21. (previously presented claim 24) The method of claim 20, further comprising polishing one or more additional topographies prior to said measuring.

Claim 22. (previously presented claim 22) The method of claim 14, wherein said spraying is conducted simultaneously with polishing one or more semiconductor topographies with the polishing system.

Claim 23. (original claim 28) The method of claim 21, further comprising applying a polishing fluid from a dispense component prior to said polishing.

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Col. 18

lines 22-23: please delete the text "and configured to move independent of an arm comprising the nozzles" since this phrase was not included in the claim when allowed.

This certificate supersedes the Certificate of Correction issued April 29, 2008.

Signed and Sealed this  
Twentieth Day of May, 2008

A handwritten signature in black ink, reading "Jon W. Dudas". The signature is stylized, with a large loop for the "J" and a cursive "Dudas".

JON W. DUDAS  
*Director of the United States Patent and Trademark Office*